

*Customer:

Pb Free

SPECIFICATION

ITEM	CHIP LED DEVICE
MODEL	SSC-THBTGFR5210
Revision Date	Rev 2.0 (090508)

[Contents]

1. Features
2. Absolute maximum ratings
3. Electro-optical characteristics
4. Characteristic diagrams
5. Soldering profile
6. Outline dimension
7. Packing
8. Reel packing structure
9. Precaution for use
10. Rank division

Customer

Approved by	Approved by	Approved by

Supplier

Drawn by	Checked by	Approved by

1. Features

- ◆ Full-color lighting SMD Chip LED which makes right-angle mounting available
- ◆ Dimension: 3.0(L)×1.35(W)×1.0(H)mm

2. Absolute Maximum Ratings

(Ta=25℃)

Parameter	Symbol	Color	Value	Unit	Remarks
Power Dissipation	P _D	Red	60	mW	-
		Green	90		
		Blue			
Forward Current	I _F	Red	25	mA	-
		Green			
		Blue			
Peak Forward Current	I _{FM} ^{*1}	Red	100	mA	-
		Green			
		Blue			
Reverse Voltage	V _R	5		V	-
Operating Temperature	T _{opr}	-30 ~ +85		℃	-
Storage Temperature	T _{stg}	-40 ~ +100		℃	-

*1 I_{FM} Conditions: Pulse width Tw ≤ 1ms, Duty ratio ≤ 1/20

3. Electro-optical Characteristics

(Ta=25℃)

Parameter	Symbol	Condition	Color	Min	Typ	Max	Unit
Forward Voltage	V _F	I _F =10mA	Red	-	2.1	2.3	V
			Green	-	3.1	3.5	
			Blue	-	3.0	3.4	
Zener Forward Voltage	V _{F(Z)}	I _F =10mA	Blue Green	0.6	0.8	1.5	V
Luminous Intensity ^{*2}	I _V	I _F =10mA	Red	35	50	80	mcd
			Green	100	170	200	
			Blue	20	45	80	
Dominant Wavelength	λ _d	I _F =10mA	Red	610	625	640	nm
			Green	510	525	540	
			Blue	462	470	478	
Spectral Bandwidth	Δλ	I _F =10mA	Red	-	20	-	nm
			Green	-	35	-	
			Blue	-	25	-	
Viewing angle ^{*3}	2θ _{1/2}	I _F =10mA	Red	-	150	-	°
			Green	-	150	-	
			Blue	-	150	-	

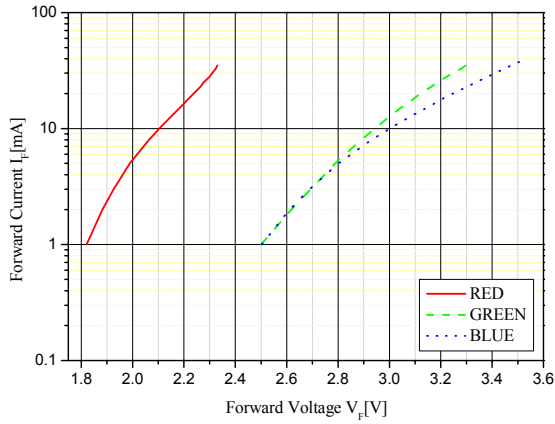
*2 The luminous intensity I_V is measured at the peak of the spatial pattern which may not be aligned with the mechanical axis of the LED package.

*3 θ_{1/2} is the off-axis where the luminous intensity is 1/2 the peak intensity.

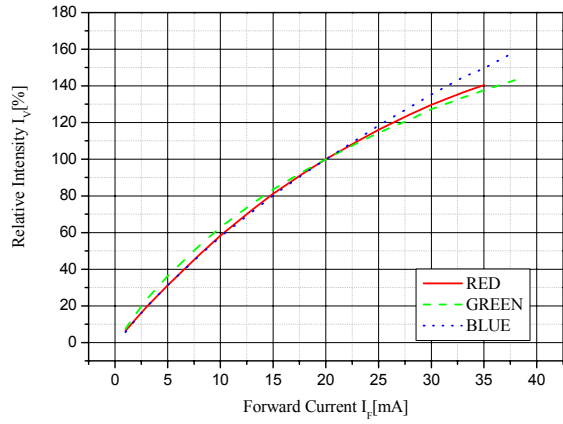
[Note] All products confirm to the listed minimum and maximum specifications for electric and optical characteristics, when operated at 10mA within the maximum ratings shown above. All measurements were made under the standardized environment of SSC.
(Tolerance: V_F ±0.1V, I_V ±10%, λ_d ±2nm)

4. Characteristic Diagrams

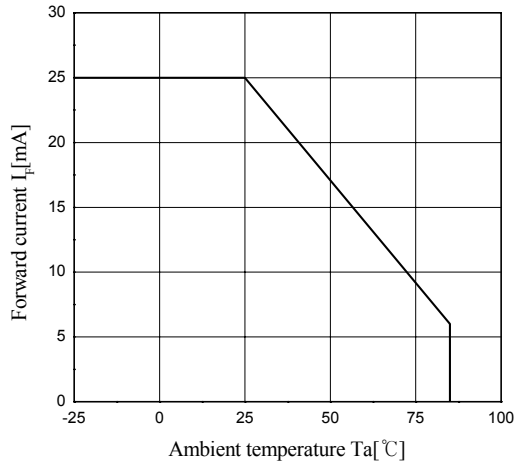
Forward Current vs. Forward Voltage



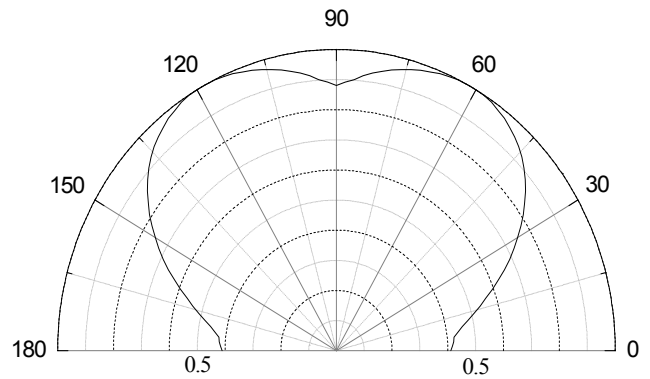
Luminous Intensity vs. Forward Current



Forward Current Derating Curve



Radiation Diagram



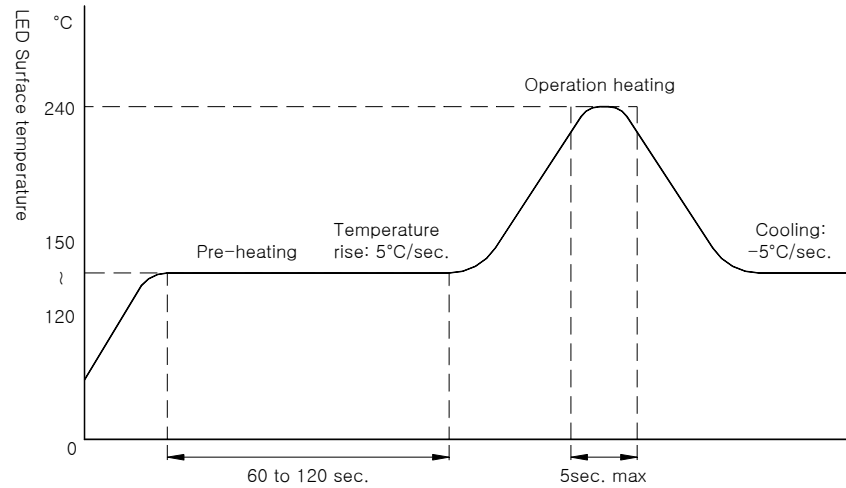
5. Soldering Profile

Reflow Soldering Conditions/ Profile

(1) Lead Solder

-Preliminary heating to be at 150°C max. for 2 minutes max.

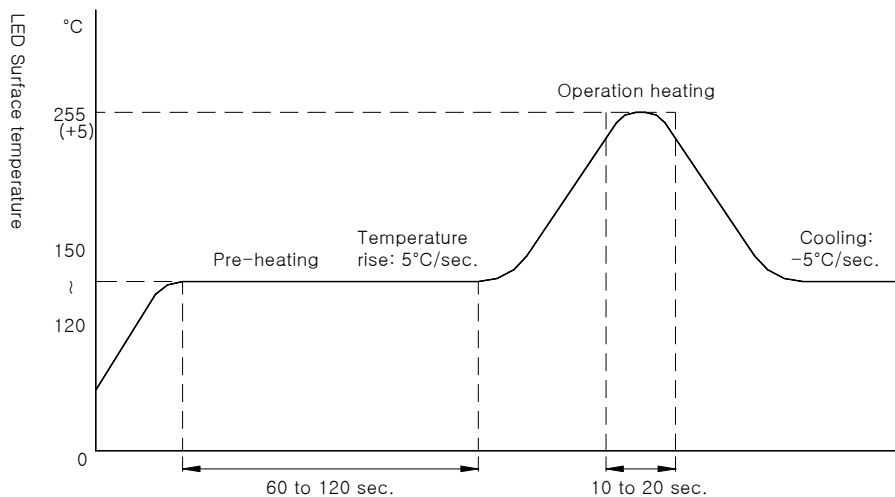
-Soldering heat to be at 240°C max. for 5 seconds max.



(2) Lead-Free Solder

-Preliminary heating to be at 150°C max. for 2 minutes max.

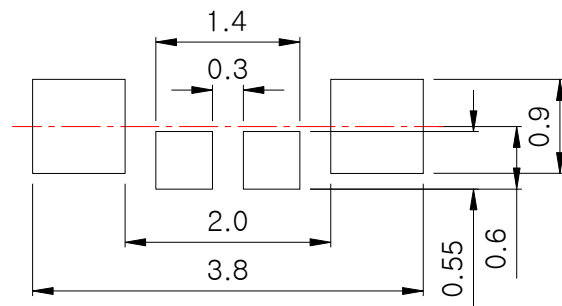
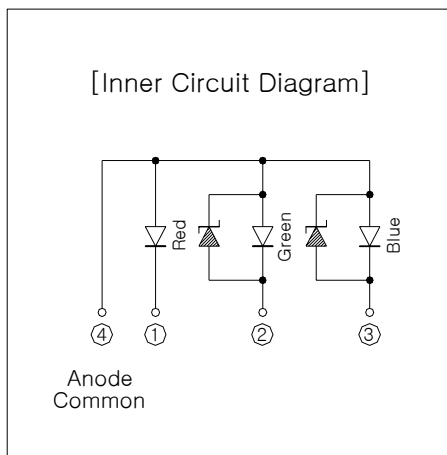
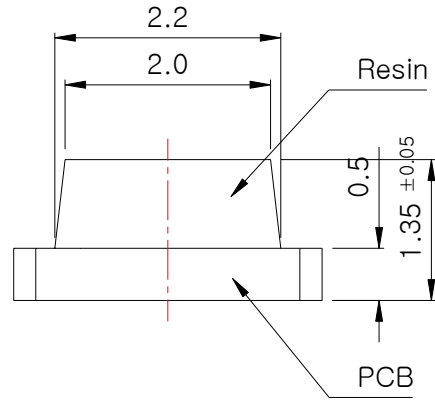
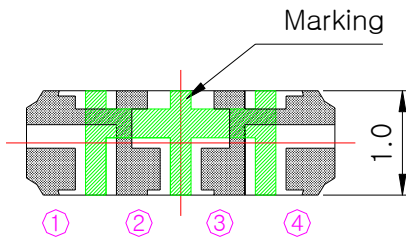
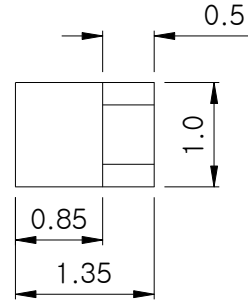
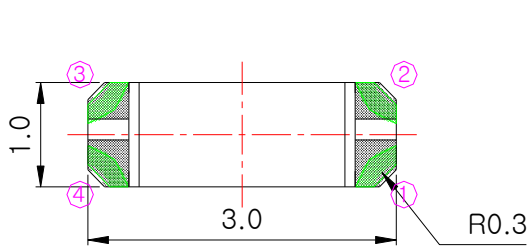
-Soldering heat to be at 255°C max. for 20 seconds max.



(3) Hand Soldering conditions

-Not more than 3 seconds @MAX280°C, under Soldering iron.

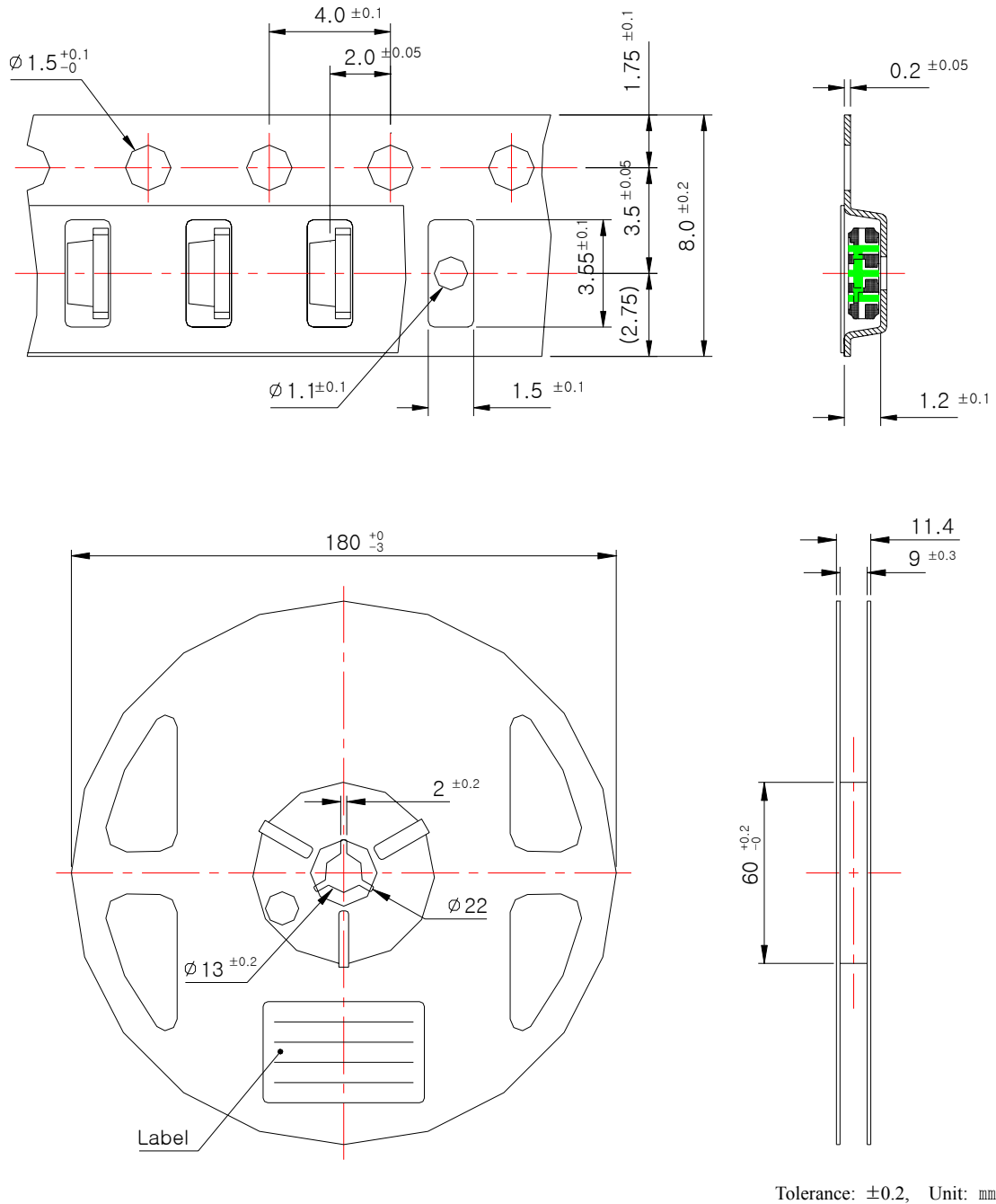
6. Outline Dimension



[Recommended Solder Pattern]

Tolerance: ±0.1, Unit: mm

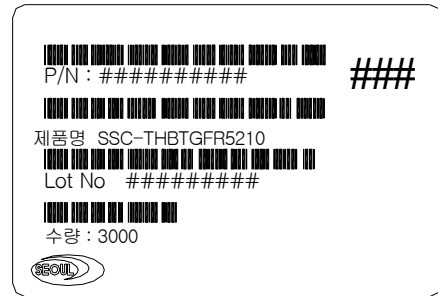
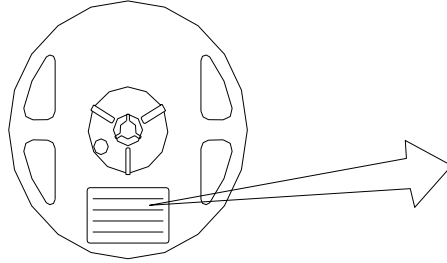
7. Packing



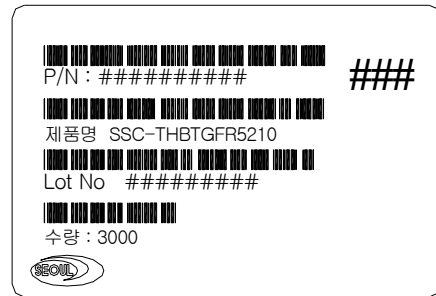
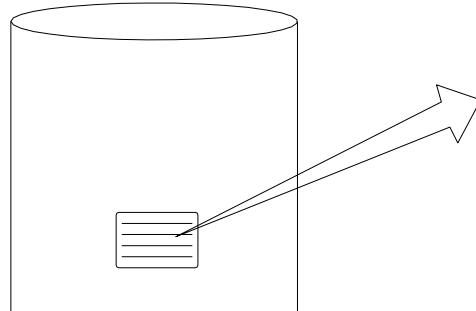
- (1) Quantity : 3000pcs/Reel
- (2) Cumulative Tolerance : Cumulative Tolerance/10pitches to be ± 0.2 mm
- (3) Adhesion Strength of Cover Tape : Adhesion strength to be 0.1-0.7N when the cover tape is turned off from the carrier tape at 10° angle to be the carrier tape.
- (4) Package : P/N, Manufacturing data Code No. and quantity to be indicated on a damp proof Package.

8. Reel Packing Structure

Reel

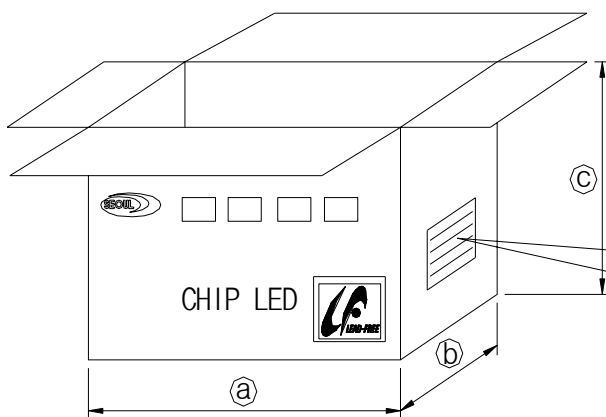


Aluminum Vinyl Bag

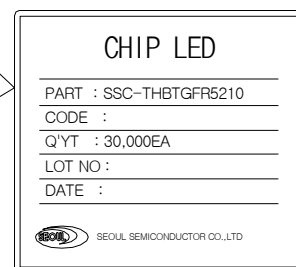


Outer Box

*Material : Paper(SW3B(B))



TYPE	SIZE(mm)		
	a	b	c
7inch	245	220	142



9. Precaution for use

(1) Storage

In order to avoid the absorption of moisture, it is recommended to store in the dry box (or desiccator) with a desiccant . Otherwise, to store them in the following environment is recommended.

Temperature : 5℃~30℃ Humidity : 60%HR max.

(2) Attention after opened

However LED is correspond SMD, when LED be soldered dip, interfacial separation may affect the light transmission efficiency, causing the light intensity to drop. Attention in followed.

a. After opened and mounted, the soldering shall be quickly. b. Keeping of a fraction

Temperature : 5 ~ 40℃ Humidity : less than 30%

(3) In case of more than 1 week passed after opening or change color of indicator on desiccant components shall be dried 10-12hr. at 60±5℃.

(4) In case of supposed the components is humid, shall be dried dip-solder just before.

100Hr at 80±5℃ or 12Hr at 100±5℃.

(5) Any mechanical force or any excess vibration shall not be accepted to apply during cooling process to normal temp. after soldering.

(6) Quick cooling shall not be avoid.

(7) Components shall not be mounted on warped direction of PCB.

(8) Anti radioactive ray design is not considered for the products listed here in.

(9) This device should not be used in any type of fluid such as water, oil, organic solvent and etc. When washing is required, IPA should be used.

(10) When the LEDs are illuminating, operating current should be decided after considering the ambient maximum temperature.

(11) LEDs must be stored to maintain a clean atmosphere. If the LEDs are stored for 3 months or more after being shipped from SSC, a sealed container with a nitrogen atmosphere should be used for storage.

(12) The LEDs must be soldered within seven days after opening the moisture-proof packing.

(13) Repack unused products with anti-moisture packing, fold to close any opening and then store in a dry place.

(14) The appearance and specifications of the product may be modified for improvement without notice.

(15) Static Electricity and surge damages the Blue/Green LEDs.

It is recommended to use a wrist band or anti-electrostatic glove when handling the LEDs.

All devices, equipment and machinery must be properly grounded.

(16) It is recommended to use individual resistor separately when the LEDs applies in parallel circuit so that it may improve the light deviations.

(17) It is recommended to examine to the full the circuit by using resistor when the LEDs applies in case of lighting seven colors. (White color is not available with single LED.)

10. Rank Division

V _F [V]			λ _D [nm]			I _V [mcd]			Bin
I _F =10mA			I _F =10mA			I _F =10mA			
RED	GREEN	BLUE	RED	GREEN	BLUE	RED	GREEN	BLUE	
1.70~2.30	2.70~2.90	2.70~2.90	610~640	510~540	462~470	35~80	100~200	20~80	BBB
					470~478	35~80	100~200	20~80	BBC
		2.90~3.10	610~640	510~540	462~470	35~80	100~200	20~80	BCB
					470~478	35~80	100~200	20~80	BCC
		3.10~3.40	610~640	510~540	462~470	35~80	100~200	20~80	BDB
					470~478	35~80	100~200	20~80	BDC
	2.90~3.10	2.70~2.90	610~640	510~540	462~470	35~80	100~200	20~80	CBB
					470~478	35~80	100~200	20~80	CBC
		2.90~3.10	610~640	510~540	462~470	35~80	100~200	20~80	CCB
					470~478	35~80	100~200	20~80	CCC
		3.10~3.40	610~640	510~540	462~470	35~80	100~200	20~80	CDB
					470~478	35~80	100~200	20~80	CDC
	3.10~3.30	2.70~2.90	610~640	510~540	462~470	35~80	100~200	20~80	DBB
					470~478	35~80	100~200	20~80	DBC
		2.90~3.10	610~640	510~540	462~470	35~80	100~200	20~80	DCB
					470~478	35~80	100~200	20~80	DCC
		3.10~3.40	610~640	510~540	462~470	35~80	100~200	20~80	DDB
					470~478	35~80	100~200	20~80	DDC
	3.30~3.50	2.70~2.90	610~640	510~540	462~470	35~80	100~200	20~80	EBB
					470~478	35~80	100~200	20~80	EBC
		2.90~3.10	610~640	510~540	462~470	35~80	100~200	20~80	ECB
					470~478	35~80	100~200	20~80	ECC
		3.10~3.40	610~640	510~540	462~470	35~80	100~200	20~80	EDB
					470~478	35~80	100~200	20~80	EDC